HALOGEN FREE



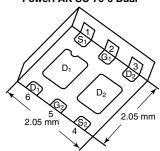
www.vishay.com

Vishay Siliconix

# **Dual N-Channel 20 V (D-S) MOSFET**

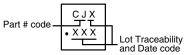
PRODUCT SUMMARY									
V <sub>DS</sub> (V)	R <sub>DS(on)</sub> (Ω) Max.	I <sub>D</sub> (A) <sup>a</sup>	Q <sub>g</sub> (Typ.)						
20	0.043 at V <sub>GS</sub> = 4.5 V	4.5							
	0.045 at V <sub>GS</sub> = 3.7 V	4.5	3.5 nC						
	0.050 at V <sub>GS</sub> = 2.5 V	4.5	3.5110						
	0.063 at V <sub>GS</sub> = 1.8 V	4.5							

#### PowerPAK SC-70-6 Dual



Ordering Information: SiA914ADJ-T1-GE3 (Lead (Pb)-free and Halogen-free)

#### **Marking Code**

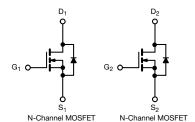


#### **FEATURES**

- TrenchFET® Power MOSFET
- Thermally Enhanced PowerPAK® SC-70 Package
  - Small Footprint Area
  - Low On-Resistance
- 100 % R<sub>a</sub> Tested
- Material categorization: For definitions of compliance please see <a href="https://www.vishav.com/doc?99912">www.vishav.com/doc?99912</a>

#### APPLICATIONS

- Portable Devices such as Smart Phones, Tablet PCs and Mobile Computing
  - Load Switch
  - DC/DC Converter
  - Power Management



Parameter		Symbol	Limit	Unit	
Drain-Source Voltage		$V_{DS}$	20	V	
Gate-Source Voltage		$V_{GS}$	± 8	v	
	T <sub>C</sub> = 25 °C		4.5 <sup>a</sup>		
Continuous Dunis Comment (T. 150 %C)	T <sub>C</sub> = 70 °C	1 .	4.5 <sup>a</sup>	7	
Continuous Drain Current (T <sub>J</sub> = 150 °C)	T <sub>A</sub> = 25 °C	l <sub>D</sub>	4.5 <sup>a, b, c</sup>	7	
	T <sub>A</sub> = 70 °C		4.3 <sup>b, c</sup>	Α	
Pulsed Drain Current (t = 100 μs)	•	I <sub>DM</sub>	30	1	
Continuos Como Durio Diado Como t	T <sub>C</sub> = 25 °C		4.5 <sup>a</sup>	1	
Continuous Source-Drain Diode Current	T <sub>A</sub> = 25 °C	Is	1.6 <sup>b, c</sup>		
	T <sub>C</sub> = 25 °C		7.8		
Manipular Davida Disabilitation	T <sub>C</sub> = 70 °C	_	5	14/	
Maximum Power Dissipation	T <sub>A</sub> = 25 °C	$P_{D}$	1.9 <sup>b, c</sup>	W	
	T <sub>A</sub> = 70 °C		1.2 <sup>b, c</sup>	7	
Operating Junction and Storage Temperatur	re Range	T <sub>J</sub> , T <sub>stg</sub>	- 55 to 150	00	
Soldering Recommendations (Peak Tempera	ature) <sup>d, e</sup>		260	°C	

THERMAL RESISTANCE RATINGS										
Parameter		Symbol	Typical	Maximum	Unit					
Maximum Junction-to-Ambient <sup>b, f</sup>	t ≤ 5 s	$R_{thJA}$	52	65	°C/W					
Maximum Junction-to-Case (Drain)	Steady State	R <sub>thJC</sub>	12.5	16	]					

#### Notes

- a. Package limited.
- b. Surface mounted on 1" x 1" FR4 board.
- c. t = 5 s.
- d. See solder profile (<a href="www.vishay.com/doc?73257">www.vishay.com/doc?73257</a>). The PowerPAK SC-70 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.
- e. Rework conditions: manual soldering with a soldering iron is not recommended for leadless components.
- f. Maximum under steady state conditions is 110 °C/W.



# Vishay Siliconix

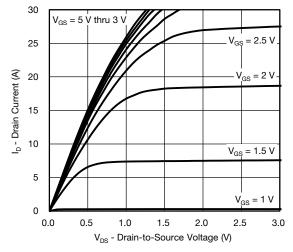
Static  Drain-Source Breakdown Voltage  V <sub>DS</sub> Temperature Coefficient  V <sub>GS(th)</sub> Temperature Coefficient  Gate-Source Threshold Voltage  Gate-Source Leakage  Zero Gate Voltage Drain Current	$V_{DS}$ $\Delta V_{DS}/T_J$ $\Delta V_{GS(th)}/T_J$	V <sub>GS</sub> = 0 V, I <sub>D</sub> = 250 μA				
V <sub>DS</sub> Temperature Coefficient V <sub>GS(th)</sub> Temperature Coefficient Gate-Source Threshold Voltage Gate-Source Leakage	$\Delta V_{DS}/T_{J}$ $\Delta V_{GS(th)}/T_{J}$	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$				
V <sub>GS(th)</sub> Temperature Coefficient Gate-Source Threshold Voltage Gate-Source Leakage	$\Delta V_{DS}/T_{J}$ $\Delta V_{GS(th)}/T_{J}$		20			V
Gate-Source Threshold Voltage Gate-Source Leakage		1 050 4		18		mV/°C
Gate-Source Leakage		I <sub>D</sub> = 250 μA		- 2.5		
· ·	V <sub>GS(th</sub> )	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	0.4		0.9	V
Zoro Gato Voltago Drain Current	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 8 \text{ V}$			± 100	nA
	,	V <sub>DS</sub> = 20 V, V <sub>GS</sub> = 0 V			1	μΑ
Zeio Gate Voltage Drain Gurrent	I <sub>DSS</sub>	V <sub>DS</sub> = 20 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 55 °C			10	
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \ge 5 \text{ V}, V_{GS} = 4.5 \text{ V}$	10			Α
		$V_{GS} = 4.5 \text{ V}, I_D = 3.7 \text{ A}$		0.035	0.043	Ω
Dunin Course On Chata Basistanas	Б	$V_{GS} = 3.7 \text{ V}, I_D = 3 \text{ A}$		0.036	0.045	
Drain-Source On-State Resistance <sup>a</sup>	R <sub>DS(on)</sub>	$V_{GS} = 2.5 \text{ V}, I_D = 3 \text{ A}$		0.040	0.050	
		V <sub>GS</sub> = 1.8 V, I <sub>D</sub> = 1 A		0.047	0.063	
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	$V_{DS} = 10 \text{ V}, I_D = 3.7 \text{ A}$		18		S
Dynamic <sup>b</sup>						
Input Capacitance	C <sub>iss</sub>			470		
Output Capacitance	C <sub>oss</sub>	$V_{DS} = 10 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$		75		pF
Reverse Transfer Capacitance	C <sub>rss</sub>			26		
Tatal Oats Obarra		V <sub>DS</sub> = 10 V, V <sub>GS</sub> = 8 V, I <sub>D</sub> = 6 A		8.2	12.5	nC
Total Gate Charge	$Q_g$			4.6	7	
Gate-Source Charge	$Q_{gs}$	$V_{DS} = 10 \text{ V}, V_{GS} = 4.5 \text{ V}, I_D = 6 \text{ A}$		0.65		
Gate-Drain Charge	Q <sub>gd</sub>			0.6		
Gate Resistance	$R_{g}$	f = 1 MHz	0.6	3	6	Ω
Turn-On Delay Time	t <sub>d(on)</sub>			7	15	
Rise Time	t <sub>r</sub>	$V_{DD} = 10 \text{ V}, R_{I} = 2.1 \Omega$		20	40	
Turn-Off DelayTime	t <sub>d(off)</sub>	$I_D \cong 4.8 \text{ A}, V_{GEN} = 4.5 \text{ V}, R_g = 1 \Omega$		25	50	
Fall Time	t <sub>f</sub>			5	10	
Turn-On Delay Time	t <sub>d(on)</sub>			5	10	ns
Rise Time	t <sub>r</sub>	$V_{DD} = 10 \text{ V}, R_{I} = 2.1 \Omega$		5	10	
Turn-Off DelayTime	t <sub>d(off)</sub>	$I_D \cong 4.8 \text{ A}, V_{GEN} = 8 \text{ V}, R_g = 1 \Omega$		20	40	
Fall Time	t <sub>f</sub>			5	10	
Drain-Source Body Diode Characteristic	s		1	L		
-		T <sub>C</sub> = 25 °C			4.5	
Pulse Diode Forward Current (t = 100 μs)	I <sub>S</sub>	-	1		30	Α
Body Diode Voltage V		I <sub>S</sub> = 4.8 A, V <sub>GS</sub> = 0 V	1	0.85	1.2	V
Body Diode Reverse Recovery Time	t <sub>rr</sub>		1	9.5	20	ns
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>	1		3	10	nC
Reverse Recovery Fall Time	ta	$I_F = 4.8 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, T_J = 25 ^{\circ}\text{C}$		5		
Reverse Recovery Rise Time	t <sub>b</sub>			4.5		ns

#### Notes

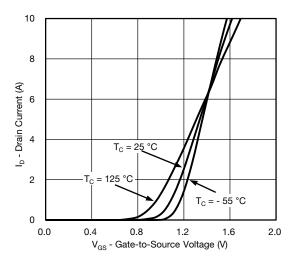
- a. Pulse test; pulse width  $\leq$  300  $\mu$ s, duty cycle  $\leq$  2 %.
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

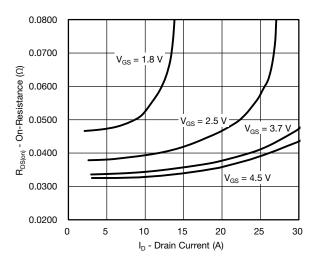




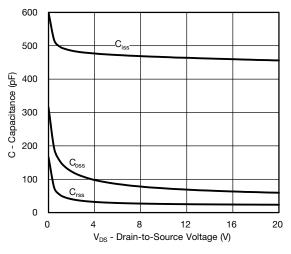
### **Output Characteristics**



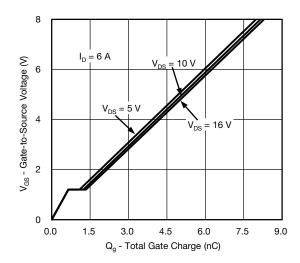
**Transfer Characteristics** 



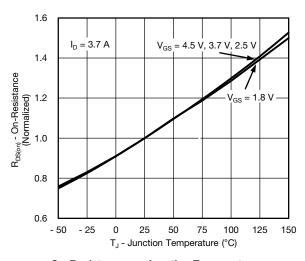
On-Resistance vs. Drain Current and Gate Voltage



Capacitance

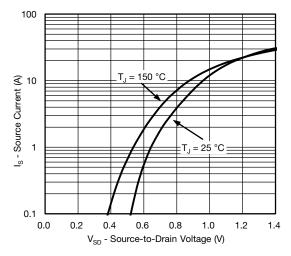


**Gate Charge** 

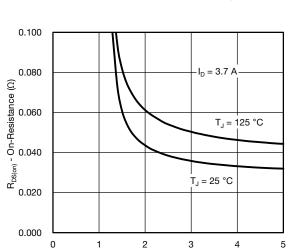


On-Resistance vs. Junction Temperature



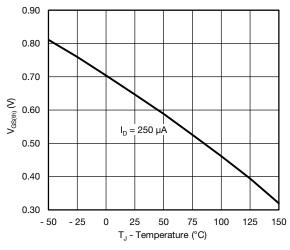


#### Source-Drain Diode Forward Voltage

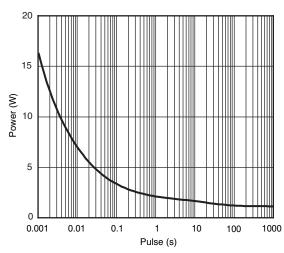


On-Resistance vs. Gate-to-Source Voltage

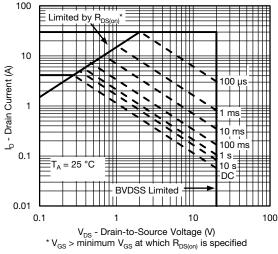
- Gate-to-Source Voltage (V)



**Threshold Voltage** 

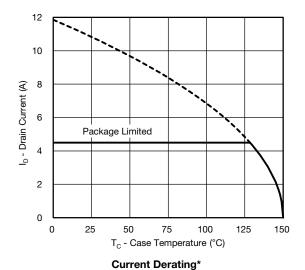


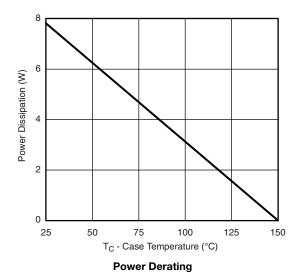
Single Pulse Power (Junction-to-Ambient)



Safe Operating Area, Junction-to-Ambient

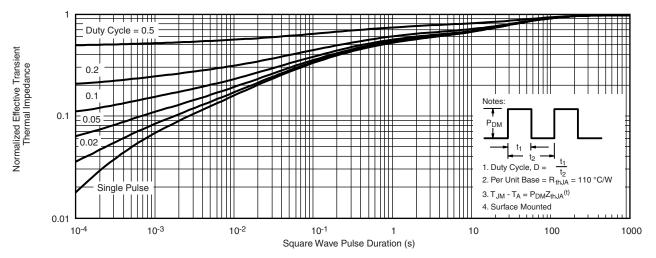




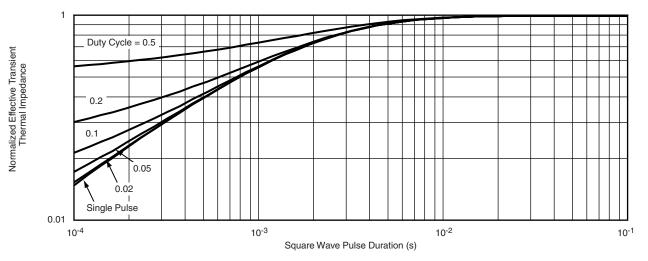


\* The power dissipation  $P_D$  is based on  $T_{J(max.)} = 150$  °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.





Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

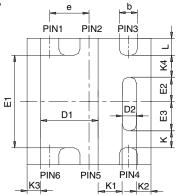
Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see <a href="https://www.vishay.com/ppg?62872">www.vishay.com/ppg?62872</a>.





Vishay Siliconix

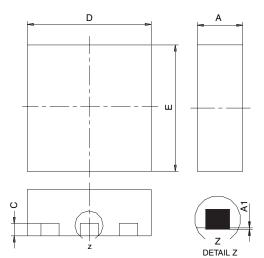
# PowerPAK® SC70-6L





BACKSIDE VIEW OF SINGLE

BACKSIDE VIEW OF DUAL



- All dimensions are in millimeters
   Package outline exclusive of mold flash and metal burr
   Package outline inclusive of plating

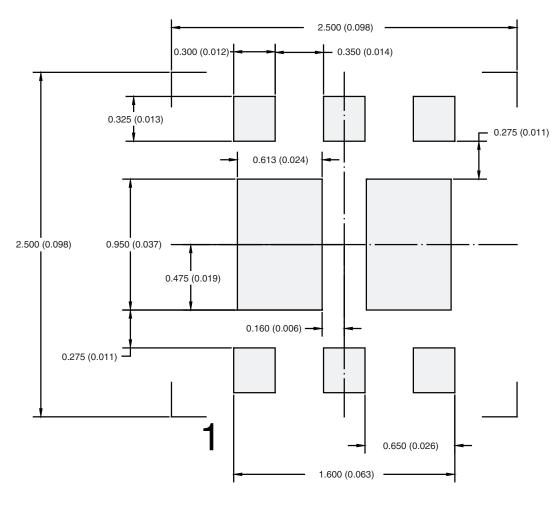
	SINGLE PAD						DUAL PAD						
DIM	MILLIMETERS			INCHES			MILLIMETERS			INCHES			
	Min	Nom	Max	Min	Nom	Max	Min	Nom	Max	Min	Nom	Max	
Α	0.675	0.75	0.80	0.027	0.030	0.032	0.675	0.75	0.80	0.027	0.030	0.032	
<b>A</b> 1	0	-	0.05	0	-	0.002	0	-	0.05	0	-	0.002	
b	0.23	0.30	0.38	0.009	0.012	0.015	0.23	0.30	0.38	0.009	0.012	0.015	
С	0.15	0.20	0.25	0.006	0.008	0.010	0.15	0.20	0.25	0.006	0.008	0.010	
D	1.98	2.05	2.15	0.078	0.081	0.085	1.98	2.05	2.15	0.078	0.081	0.085	
D1	0.85	0.95	1.05	0.033	0.037	0.041	0.513	0.613	0.713	0.020	0.024	0.028	
D2	0.135	0.235	0.335	0.005	0.009	0.013							
E	1.98	2.05	2.15	0.078	0.081	0.085	1.98	2.05	2.15	0.078	0.081	0.085	
E1	1.40	1.50	1.60	0.055	0.059	0.063	0.85	0.95	1.05	0.033	0.037	0.041	
E2	0.345	0.395	0.445	0.014	0.016	0.018							
E3	0.425	0.475	0.525	0.017	0.019	0.021							
е		0.65 BSC			0.026 BSC			0.65 BSC			0.026 BSC		
K		0.275 TYP	١		0.011 TYP		0.275 TYP			0.011 TYP			
K1		0.400 TYP	١		0.016 TYP			0.320 TYP			0.013 TYP		
K2		0.240 TYP 0.009 TYP			0.252 TYP			0.010 TYP					
К3		0.225 TYP	1	0.009 TYP									
K4		0.355 TYP	1	0.014 TYP									
L	0.175	0.275	0.375	0.007	0.011	0.015	0.175	0.275	0.375	0.007	0.011	0.015	
Т							0.05	0.10	0.15	0.002	0.004	0.006	
FCN: C-07431 - Bey. C. 06-Aug-07													

DWG: 5934

Document Number: 73001 06-Aug-07



# RECOMMENDED PAD LAYOUT FOR PowerPAK® SC70-6L Dual



Dimensions in mm (inches)

Return to Index

www.vishay.com



# **Legal Disclaimer Notice**

Vishay

# **Disclaimer**

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and / or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.

Revision: 13-Jun-16 1 Document Number: 91000

# **Mouser Electronics**

**Authorized Distributor** 

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

Vishay: SIA914ADJ-T1-GE3